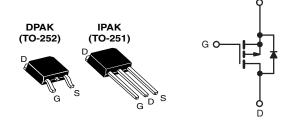


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	- 60					
R _{DS(on)} (Ω)	V _{GS} = - 10 V	0.28				
Q _g (Max.) (nC)	19					
Q _{gs} (nC)	5.4					
Q _{gd} (nC)	11					
Configuration	Single					



P-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR9024, SiHFR9024)
- Straight Lead (IRFU9024, SiHFU9024)
- Available in Tape and Reel
- P-Channel
- Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effictiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFO	ORMATION				
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)
Lead (Pb)-free and Halogen-free	SiHFR9024-GE3	SiHFR9024TR-GE3ª	SiHFR9024TRL-GE3 ^a	SiHFR9024TRR-GE3ª	SiHFU9024-GE3
Lead (Pb)-free	IRFR9024PbF	IRFR9024TRPbF ^a	IRFR9024TRLPbFa	IRFR9024TRRPbF ^a	IRFU9024PbF
	SiHFR9024-E3	SiHFR9024T-E3 ^a	SiHFR9024TL-E3 ^a	SiHFR9024TR-E3 ^a	SiHFU9024-E3

Note

a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	- 60	v	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current	1-	- 8.8			
Continuous Drain Gurrent	I _D	- 5.6	А		
Pulsed Drain Current ^a		I _{DM}	- 35		
Linear Derating Factor		0.33	W/°C		
Linear Derating Factor (PCB Mount) ^e			0.020	W/ C	
Single Pulse Avalanche Energy ^b		E _{AS}	300	mJ	
Repetitive Avalanche Current ^a			I _{AR}	- 8.8	Α
Repetitive Avalanche Energy ^a			E _{AR}	5.0	mJ
Maximum Power Dissipation	25 °C	D	42	14/	
Maximum Power Dissipation (PCB Mount) ^e	P _D	2.5	W		
Peak Diode Recovery dV/dt ^c	dV/dt	- 4.5	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	- °C	
Soldering Recommendations (Peak Temperature) ^d	Soldering Recommendations (Peak Temperature) ^d for 10 s				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = -25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 4.5 mH, $R_g = 25 \Omega$, $I_{AS} = -8.8 \text{ A}$ (see fig. 12). c. $I_{SD} \leq -11 \text{ A}$, dl/dt $\leq 140 \text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DS}$, $T_J \leq 150 \text{ °C}$.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

S13-0168-Rev. D, 04-Feb-13

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HALOGEN

FREE Available



Vishay Siliconix

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	-	110			
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		<u>.</u>					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 1 mA	-	- 0.063	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 20 V	-	-	± 100	nA
		V _{DS} =	- 60 V, V _{GS} = 0 V	-	-	- 100	<u> </u>
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 48 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	- 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 5.3 A ^b	-	-	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	- 25 V, I _D = - 5.3 A	2.9	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	570	-	
Output Capacitance	C _{oss}		$V_{DS} = -25 V,$	-	360	-	pF
Reverse Transfer Capacitance	C _{rss}		f = 1.0 MHz	-	65	-	
Total Gate Charge	Qg			-	-	19	
Gate-Source Charge	Q_gs	V _{GS} = - 10 V	$I_D = -11 \text{ A}, V_{DS} = -48 \text{ V},$ see fig. 6 and 13^{b}	-	-	5.4	nC
Gate-Drain Charge	Q _{gd}			-	-	11	
Turn-On Delay Time	t _{d(on)}			-	13	-	
Rise Time	t _r	V _{DD} =	- 30 V, I _D = - 11 A,	-	68	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 18 \Omega$,	$R_D = 2.5 \Omega$, see fig. 10^{b}	-	15	-	ns
Fall Time	t _f			-	29	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25")	from	-	4.5	-	
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	nH
Drain-Source Body Diode Characteristic	s	-					
Continuous Source-Drain Diode Current	I _S	MOSFET s showing	the	-	-	- 8.8	A
Pulsed Diode Forward Current ^a	I _{SM}	integral re p - n junctio		-	-	- 35	~
Body Diode Voltage	V_{SD}	T _J = 25 °C,	$I_{\rm S}$ = - 8.8 A, $V_{\rm GS}$ = 0 V ^b	-	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	T 25 °C I	= - 11 A, dl/dt = 100 A/µs ^b	-	100	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25$ C, I _F	$=$ - 11 A, u/ul = 100 A/ μ S ^o	-	0.32	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	$v L_s$ and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

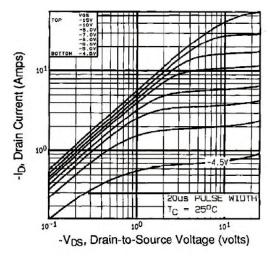


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

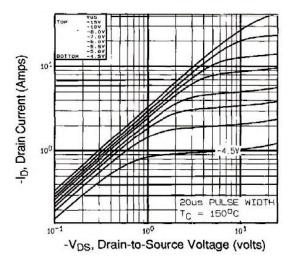


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

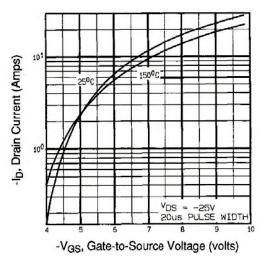


Fig. 3 - Typical Transfer Characteristics

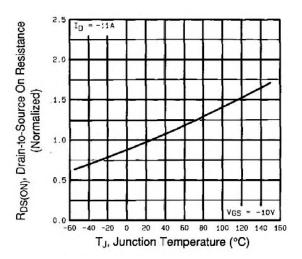


Fig. 4 - Normalized On-Resistance vs. Temperature



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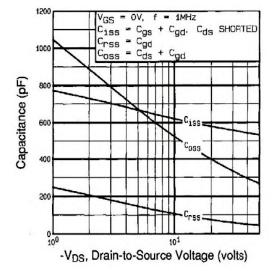


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

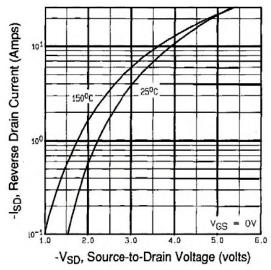


Fig. 7 - Typical Source-Drain Diode Forward Voltage

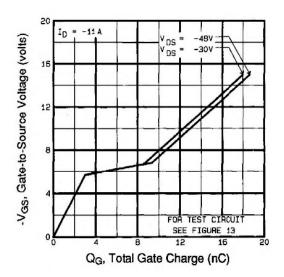


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

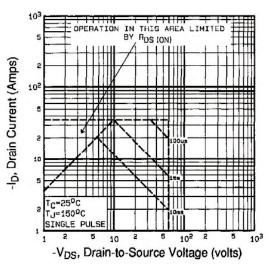


Fig. 8 - Maximum Safe Operating Area



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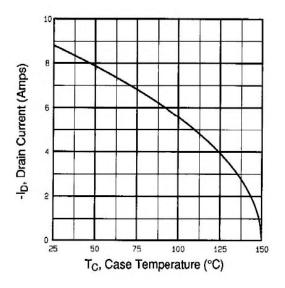


Fig. 9 - Maximum Drain Current vs. Case Temperature

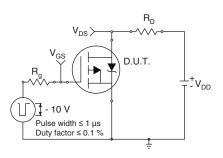


Fig. 10a - Switching Time Test Circuit

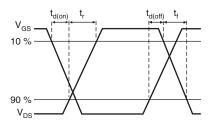


Fig. 10b - Switching Time Waveforms

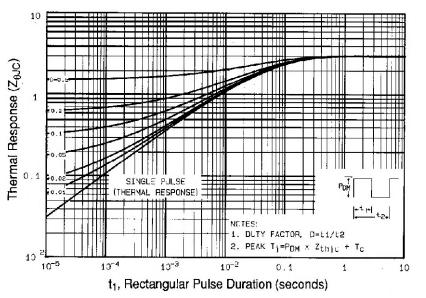


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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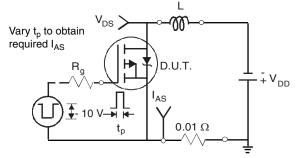


Fig. 12a - Unclamped Inductive Test Circuit

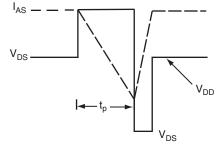


Fig. 12b - Unclamped Inductive Waveforms

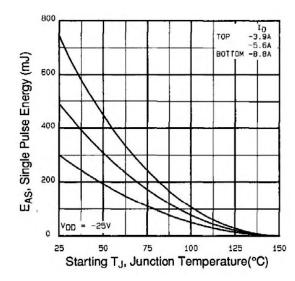


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

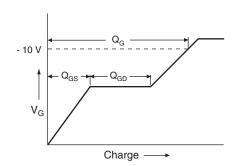


Fig. 13a - Basic Gate Charge Waveform

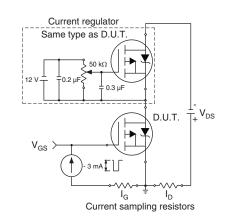


Fig. 13b - Gate Charge Test Circuit

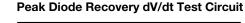
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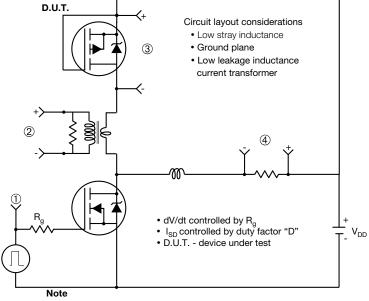
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• Compliment N-Channel of D.U.T. for driver

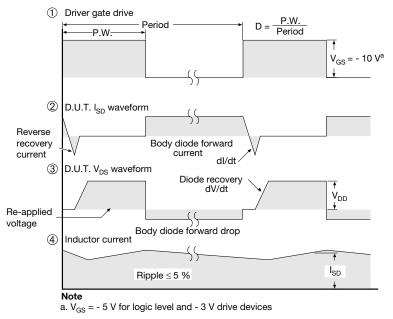
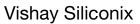


Fig. 14 - For P-Channel

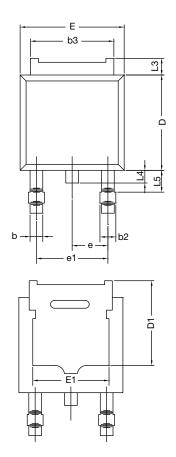
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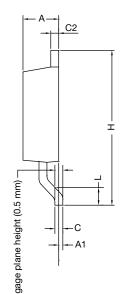
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TO-252AA Case Outline





	MILLIN	IETERS	S INCHES			
DIM.	MIN.	MAX.	MIN.	MAX.		
А	2.18	2.38	0.086	0.094		
A1	-	0.127	-	0.005		
b	0.64	0.88	0.025	0.035		
b2	0.76	1.14	0.030	0.045		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
C2	0.46	0.89	0.018	0.035		
D	5.97	6.22	0.235	0.245		
D1	4.10	-	0.161	-		
Е	6.35	6.73	0.250	0.265		
E1	4.32	-	0.170	-		
Н	9.40	10.41	0.370	0.410		
е	2.28	BSC	0.090 BSC			
e1	4.56	BSC	0.180 BSC			
L	1.40	1.78	0.055	0.070		
L3	0.89	1.27	0.035	0.050		
L4	-	1.02	-	0.040		
L5	1.01	1.52	0.040	0.060		
ECN: T16- DWG: 534	0236-Rev. P, [•] 7	16-May-16				

Notes

• Dimension L3 is for reference only.



Vishay Siliconix

TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INC	HES		MILLI	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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Vishay

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